

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Junction Temperature:	-65°C to +200°C
Storage Temperature:	-65°C to +175°C
Thermal Resistance:	22°C/W junction to lead @ 3/8" lead length from body
Thermal Impedance:	1.5°C/W ms heating time
Average Rectified Forward Current (I_o):	5 Amps @ T _L = 55°C (see Note 1)
Forward Surge Current (8.3 ms half sine):	100 Amps
Solder Temperatures:	260°C for 10 s (maximum)

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

Type	Minimum Breakdown Voltage V _{BR} @ 50μA	Working Peak Reverse Voltage V _{RWM}	Average Rectified Current I _{o1} @ T _L = +55°C Note 1	Average Rectified Current I _{o2} @ T _A = +55°C Note 2	Forward Voltage V _F @ 9A (pk)		Maximum Reverse Current I _R @ V _{RWM}	Reverse Recovery t _{rr} Note 3
					Min.	Max.		
	VOLTS	VOLTS	AMPS	AMPS	VOLTS	VOLTS	μA	μs
1N5550	220	200	5	3	0.6V(pk)	1.2V(pk)	1.0	2.0
1N5551	440	400	5	3	0.6V(pk)	1.2V(pk)	1.0	2.0
1N5552	660	600	5	3	0.6V(pk)	1.2V(pk)	1.0	2.0
1N5553	880	800	5	3	0.6V(pk)	1.3V(pk)	1.0	2.0
1N5554	1100	1000	5	3	0.6V(pk)	1.3V(pk)	1.0	2.0

Note 1: Rated at T_L = 55°C at L = 0.375" from body. Derate linearly at 41.6 mA/°C above T_L = 55°C.

Note 2: Derate linearly at 25 mA/°C above T_A = 55°C. This rating is typical for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where T_{J(MAX)} rating is not exceeded.

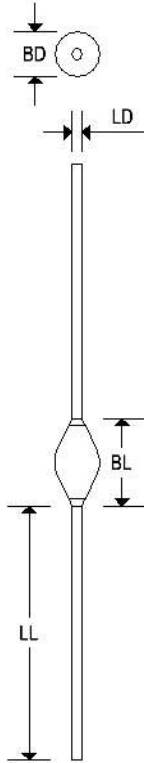
Note 3: I_F = 0.5 A, I_{RM} = 1.0 A, I_{R(REC)} = .250 A

1N5550-1N5554

STANDARD RECOVERY RECTIFIERS

MECHANICAL CHARACTERISTICS

Case:	Digi Y
Marking:	Body painted, alpha-numeric
Polarity:	Cathode band



	Digi Y			
	Inches		Millimeters	
	Min	Max	Min	Max
BD	0.115	0.180	2.920	4.570
BL	0.130	0.300	3.300	7.620
LD	0.036	0.042	0.920	1.070
LL	0.900	1.300	22.860	33.020

